

Electronic Acknowledgement Receipt	
EFS ID:	4986744
Application Number:	10588024
International Application Number:	
Confirmation Number:	1234
Title of Invention:	Repair Soldering Method for Repairing a Component Which Comprises a Base Material with an Oriented Microstructure
First Named Inventor/Applicant Name:	Dirk Goldschmidt
Customer Number:	22116
Filer:	Ye Ren/Alice McCorkle
Filer Authorized By:	Ye Ren
Attorney Docket Number:	2003P18131WOUS
Receipt Date:	18-MAR-2009
Filing Date:	31-MAY-2007
Time Stamp:	09:45:37
Application Type:	U.S. National Stage under 35 USC 371

Payment information:					
Submitted with Payment			no		
File Listing:					
Document Number	Document Description	File Name	File Size(Bytes)/ Message Digest	Multi Part /.zip	Pages (if appl.)
1	Information Disclosure Statement (IDS) Filed (SB/08)	US_IDS_Form__SB_08a.pdf	607845 38993f47d4d32dd7b15deb69d124369b3bcebc03	no	4
Warnings:					
Information:					

A U.S. Patent Number Citation or a U.S. Publication Number Citation is required in the Information Disclosure Statement (IDS) form for autoloading of data into USPTO systems. You may remove the form to add the required data in order to correct the Informational Message if you are citing U.S. References. If you chose not to include U.S. References, the image of the form will be processed and be made available within the Image File Wrapper (IFW) system. However, no data will be extracted from this form. Any additional data such as Foreign Patent Documents or Non Patent Literature will be manually reviewed and keyed into USPTO systems.

2	Foreign Reference	ref1.pdf	1219153 081cf564a04d08f9ca713bcfd8c1897178684ee7	no	19
---	-------------------	----------	---	----	----

Warnings:

Information:

3	Foreign Reference	ref2.pdf	547430 af93c02590b81e2077a0a7f585cb097bccaa4c26	no	10
---	-------------------	----------	--	----	----

Warnings:

Information:

4	Miscellaneous Incoming Letter	searchreport.pdf	446141 2c2a566452552aa7ff67710ee0695320675f0a8c	no	5
---	-------------------------------	------------------	--	----	---

Warnings:

Information:

Total Files Size (in bytes):			2820569		
-------------------------------------	--	--	---------	--	--

This Acknowledgement Receipt evidences receipt on the noted date by the USPTO of the indicated documents, characterized by the applicant, and including page counts, where applicable. It serves as evidence of receipt similar to a Post Card, as described in MPEP 503.

New Applications Under 35 U.S.C. 111

If a new application is being filed and the application includes the necessary components for a filing date (see 37 CFR 1.53(b)-(d) and MPEP 506), a Filing Receipt (37 CFR 1.54) will be issued in due course and the date shown on this Acknowledgement Receipt will establish the filing date of the application.

National Stage of an International Application under 35 U.S.C. 371

If a timely submission to enter the national stage of an international application is compliant with the conditions of 35 U.S.C. 371 and other applicable requirements a Form PCT/DO/EO/903 indicating acceptance of the application as a national stage submission under 35 U.S.C. 371 will be issued in addition to the Filing Receipt, in due course.

New International Application Filed with the USPTO as a Receiving Office

If a new international application is being filed and the international application includes the necessary components for an international filing date (see PCT Article 11 and MPEP 1810), a Notification of the International Application Number and of the International Filing Date (Form PCT/RO/105) will be issued in due course, subject to prescriptions concerning national security, and the date shown on this Acknowledgement Receipt will establish the international filing date of the application.